

IIP Delhi/2025-26/ 730

Date 02/02/2026

CORRIGENDUM

Reference is made to Advertisement published in The Times of India (dated 29.01.2026) and Dainik Jagran (dated 29.01.2026) regarding inviting Expressions of Interest (EOI) for empanelment for providing infrastructure & mobilization support for trainings to be conducted by IIP under PMKVY 4.0 Scheme.

Following modifications/amendments are made:

1. Last date of submission has been revised to 07.02.2026 (04:00 p.m.)
2. Proposal opening date has been revised to 09.02.2026 (11:00 a.m.)
3. Point No. 15 of Document Checklist related to Price Bid has been removed.

Note: All other terms and conditions remain the same



Additional Director & Regional Officer
Indian Institute of Packaging, Delhi

DR. TANWEER ALAM
Additional Director
INDIAN INSTITUTE OF PACKAGING
PLOT NO. 21, PATPARGANJ INDUSTRIAL
ESTATE, DELHI-110 092